onsemi

N-Channel Logic Level Enhancement Mode Field Effect Transistor



SOT-323, 3 Lead, 1.25X2 CASE 419AB

BSS138W

Description

These N-Channel Enhancement Mode Field Effect Transistor. These products have been Designed to minimize on-state resistance while provide rugged, reliable, and fast switching performance.

These products are particularly suited for low voltage, low current applications such as small servo motor control, power MOSFET gate drivers, and other switching applications.

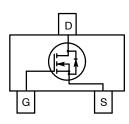
Features

- $R_{DS(on)} = 3.5 \Omega$ @ $V_{GS} = 10 V$, $I_D = 0.22 A$ $R_{DS(on)} = 6.0 \Omega$ @ $V_{GS} = 4.5 V$, $I_D = 0.22 A$
- High Density Cell Design For Extremely Low RDS(on)
- Rugged and Reliable
- Compact Industry Standard SOT-323 Surface Mount Package
- These Devices are Pb–Free and Halide Free

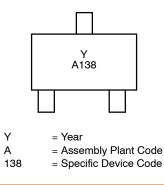
ABSOLUTE MAXIMUM RATINGS T_A = 25°C unless otherwise noted

Symbol	Parameter	Value	Unit
V _{DSS}	DSS Drain to Source Voltage		V
V _{GSS}	Gate to Source Voltage	±20	V
ID	Drain Current – Continuous (Note 1) – Pulsed	0.21 0.84	A A
T _J , T _{STG}	Operating and Storage Junction Temperature Range		
TL	Maximum Lead Temperature for Soldering Purposes, 1/16" from Case for 10 Seconds	300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.







ORDERING INFORMATION

Device	Package	Shipping †
BSS138W	SOT-323 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

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THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
P _D	Maximum Power Dissipation Derate Above 25°C (Note 1)	340 2.72	mW mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1)	367	°C/W

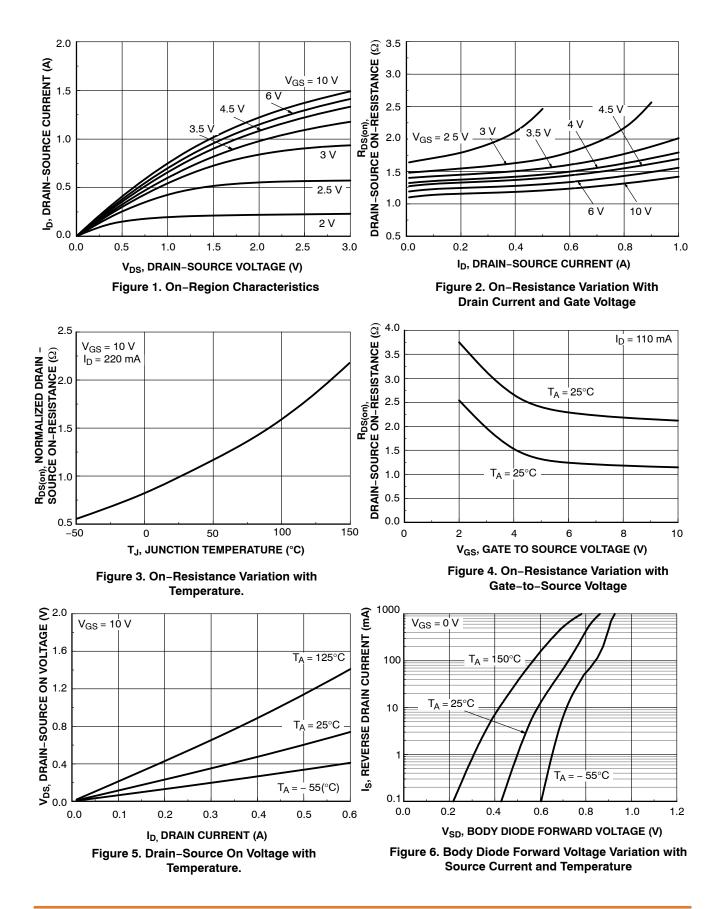
ELECTRICAL CHARACTERISTICS $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Chara	cteristics			-		
BV _{DSS}	Drain to Source Breakdown Voltage	V_{GS} = 0 V, I_D = 250 μ A	50	-	-	V
$\frac{\Delta \text{BV}_{\text{DSS(th)}}}{\Delta \text{T}_{\text{J}}}$	Breakdown Voltage Temperature Coeffi- cient	I_D = 250 µA, Referenced to 25°C	-	71	_	mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$ \begin{array}{l} V_{DS} = 50 \; V, \; V_{GS} = 0 \; V \\ V_{DS} = 50 \; V, \; V_{GS} = 0 \; V, \; T_J = 125^\circ C \\ V_{DS} = 30 \; V, \; V_{GS} = 0 \; V \end{array} $	-	-	0.5 5 100	μA μA nA
I _{GSS}	Gate-Body Leakage	V_{GS} = ±20 V, V_{DS} = 0 V	-	-	±100	nA
On Charac	cteristics (Note2)					
V _{GS(th)}	Gate to Threshold Voltage	$V_{DS} = V_{GS}, I_D = 1mA$	0.8	1.3	1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Threshold Voltage Temperature Coefficient	$I_D = 1$ mA, Referenced to 25°C	-	-3.9	_	mV/°C
R _{DS(on)}	Static Drain-Source On-Resistance	$ \begin{array}{l} V_{GS} = 10 \text{ V}, \text{ I}_{D} = 0.22 \text{ A} \\ V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 0.22 \text{ A} \\ V_{GS} = 10 \text{ V}, \text{ I}_{D} = 0.22 \text{ A}, \text{ T}_{J} = 125^{\circ}\text{C} \end{array} $	-	1.17 1.36 2.16	3.5 6.0 5.8	Ω Ω Ω
I _{D(on)}	On-State Drain Current	V _{GS} = 10 V, V _{DS} = 5 V	0.2		-	А
9 FS	Forward Transconductance	V _{DS} = 10 V, I _D = 0.22 A	0.12		-	S
Dynamic 0	Characteristics					
C _{iss}	Input Capacitance	V_{DS} = 25 V, V_{GS} = 0 V, f = 1.0 MHz	-	38	-	pF
C _{oss}	Output Capacitance		-	5.9	-	pF
C _{rss}	Reverse Transfer Capacitance		-	3.5	-	pF
Rg	Gate Resistance	V _{GS} = 15 mV, f = 1.0 MHz	-	11	-	Ω
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 30 \text{ V}, \text{ I}_{D} = 0.29 \text{ A},$	-	2.3	5	ns
t _r	Turn–On Rise Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$	-	1.9	18	ns
t _{d(off)}	Turn-Off Delay Time		-	6.7	36	ns
t _f	Turn-Off Fall Time		-	6.5	14	ns
Qg	Total Gate Change		-	1.1	-	nC
Q _{gs}	Gate-Source Change		-	0.12	-	nC
Q _{gd}	Gate-Drain Change	1	-	0.22	-	nC
Drain-Sou	Irce Diode Characteristics					
I _S	Maximum Continuous Drain-Source Diode	Forward Current	-	-	0.22	А
V_{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 0 44 A (Note 2)	-	-	1.4	V
	.					

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
1. 367°C/W When Mounted on a minimum pad.
2. Pulse Test: Pulse Width ≤ 300 µs, Duty Cycle ≤ 2.0%

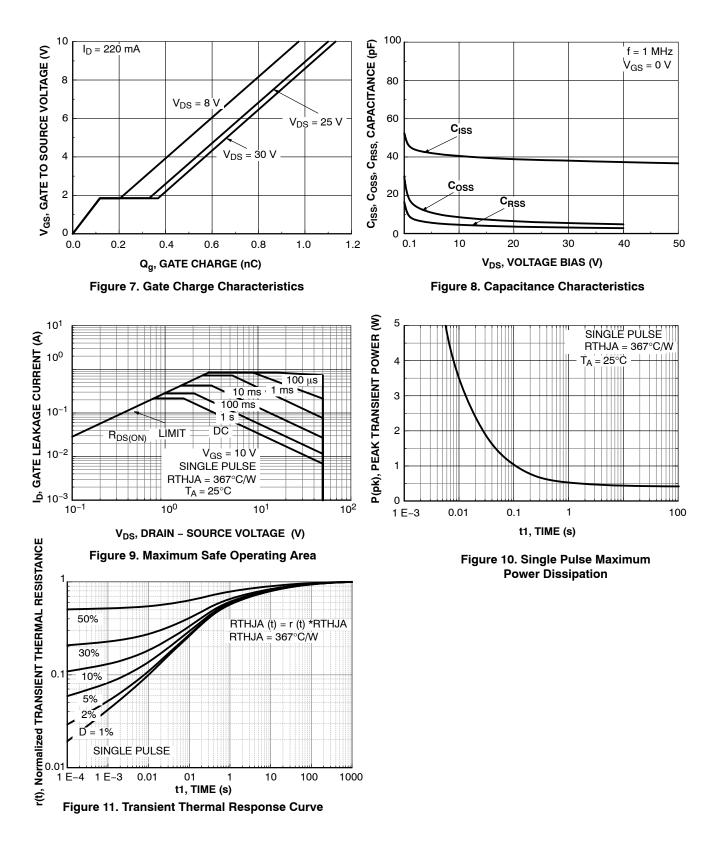
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TYPICAL CHARACTERISTICS



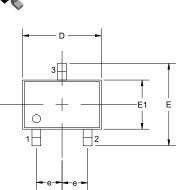
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TYPICAL CHARACTERISTICS (continued)



MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS





SC-70, 3 Lead, 1.25x2 CASE 419AB ISSUE A

DATE 13 FEB 2023

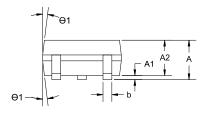
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NOTES:

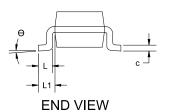
- 1. ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES IN DEGREES.
- 2. COMPLIES WITH JEDEC MO-203

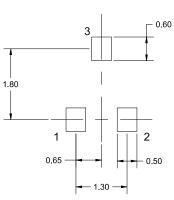
	MILLIMETERS		
DIM	MIN.	NOM.	MAX.
А	0.80		1.10
A1	0.00		0.10
A2	0.80	0.90	1.00
b	0.15		0.30
с	0.08		0.22
D	1.80	2.00	2.20
E	1.80	2.10	2.40
E1	1.15	1.25	1.35
е	0.65 BSC		
L	0.26	0.36	0.46
L1		0.42 REF	
θ	0°		8°
0 1	4°		10°





SIDE VIEW





SOLDERING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION: SC-70, 3 LEAD, 1.25X2 PAGE 1 O			PAGE 1 OF 1		
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